

PORTABLE FLAT PANEL DETECTORS

RUGGED AND RELIABLE FOR INDUSTRIAL APPLICATIONS



D-DR 1025B NDT

Bendable and high-resolution detector, perfectly suited for inspecting circumferential weld seams on pipes with diameters of 150 mm and above

- ✓ 99 µm pixel pitch (5.0 lp/mm)
- ✓ 97 x 249 mm active area
- Equipped with internal shielding for use up to 450 kV
- Innovative bending mechanism to replace traditional film
- Connection Unit with built-in wireless access point and battery
- Simple mounting system
- Exposure possible on both sides of detector
- ✓ Dust-tight and waterproof



D-DR 1043B NDT

Bendable and high-resolution detector, perfectly suited for inspecting long circumferential weld seams on pipes with diameters of 300 mm and above.

- ✓ 99 µm pixel pitch (5.0 lp/mm)
- ✓ 97 x 427 mm active area
- Equipped with internal shielding for use up to 450 kV
- Innovative bending mechanism to replace traditional film
- Connection Unit with built-in wireless access point and battery
- ✓ Simple mounting system
- Exposure possible on both sides of detector
- ✓ Dust-tight and waterproof



D-DR 7 NDT

CMOS detector for ultra-high resolution X-ray imaging. Ideal for small tubes. Can also be positioned in hard-to-reach places or even inside objects.

- √ 19 µm pixel pitch (26.3 lp/mm)
- √ 26 x 36 mm active area
- Meets aerospace standards
- ✓ Compact design
- Simple fixing system
- Robust aluminum housing
- ✓ Optional active cable extension
- Optional positioning tool with various shielding plates



The detector can be easily attached to a pipe with 2 straps and then rotated along the weld seam.



The bundled Connection Unit provides wireless connectivity and supplies the detector with power via battery.



The positioning tool allows easy placement of the D-DR 7 NDT CMOS detector as well as the attachment of shielding plates.



D-DR 1024 NDT

Compact and high-resolution detector designed for portability and the harsh conditions of industrial radiography. Perfectly suited for weld inspection.

- √ 76 µm pixel pitch (6.5 lp/mm)
- ✓ 97 x 233 mm active area
- Suitable for X-ray and gamma sources
- Equipped with internal shielding for use up to 350 kV
- Extremely robust design with detachable carry handle
- ✓ Built-in wireless access point
- Connector for Gigabit Ethernet and power
- 1 meter drop test pass
- Dust-tight and waterproof
- Optional positioning tool



D-DR 2329 NDT

Medium size high-resolution detector designed for portability and the harsh conditions of industrial radiography. The best choice for universal use.

- √ 75 µm pixel pitch (6.7 lp/mm)
- ✓ 230 x 288 mm active area
- Equipped with internal shielding for use up to 450 kV
- Hot-swap function enables battery change during operation
- ✓ Built-in wireless access point
- Connector for Gigabit Ethernet and power
- ✓ Dust-tight and waterproof



D-DR 3643 NDT

Large size detector designed for portability and the harsh conditions of industrial radiography. Perfectly suited for profile images and large objects.

- ✓ 99 µm pixel pitch (5.0 lp/mm)
- ✓ 351 x 427 mm active area
- ✓ Suitable for X-ray and gamma sources
- Equipped with internal shielding for use up to 450 kV
- ✓ Light-weight full size detector
- Extremely robust non-glass TFT sensor
- Hot-swap function enables battery change during operation
- ✓ Built-in wireless access point
- Connector for Gigabit Ethernet and power
- ✓ 1 meter drop test pass
- Dust-tight and waterproof



The carry handle and the housing can be removed to allow the detector to be inserted into hard-to-reach areas such as inside pipes.



All wireless detectors are equipped with LED status indicators for power, operation mode, battery and Wi-Fi.



The hot-swap function enables quick and easy battery change during operation.

THE PERFECT SOFTWARE SOLUTION

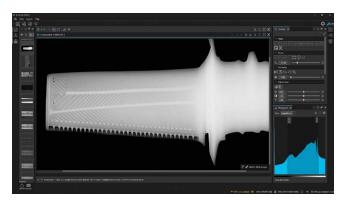
DETECT RISKS QUICKLY AND RELIABLY WITH D-TECT X

D-Tect X provides an optimal and time-saving NDT inspection workflow: from calibration and image acquisition to image evaluation and data import and export, everything you need is included and easy to use.

With a comprehensive set of features, D-Tect X is fast, intuitive and easy-to-learn. DICONDE file format support ensures that images can be viewed and processed by any other DICONDE compatible system. An interface to DRIVE NDT enables seamless NDT workflow integration. DRIVE NDT is a unique management and reporting tool and is fully integrated into D-Tect X.

- Native DICONDE file format support
- Simultaneous reference image adjustment
- X-Filter: one-click image enhancement
- Image history: track all performed image operations and define presets
- Tools to assist with working with standards (ASME, ASTM, ISO)
- Unlimited image file size support
- Report generation via direct Excel export or DRIVE NDT

- Advanced histogram tools
- SNR/SNR_N calculation
- Automatic duplex IQI detection and SR_k determination
- Advanced wall thickness analysis
- Image filters to assist with evaluation
- Length, area and angle measurement
- Image annotations with customizable detail information
- Line profile tool
- Panel calibration (offset, gain, bad pixel)
- Multi image editing/processing
- Unrestricted image zoom



Easy and reliable evaluation

Consistent quality and detection of the finest details are essential for NDT - specially designed filters and tools makes accurate and effective evaluation possible. To save time, it is also possible to save optimal evaluation settings for use with subsequent images.



Multi-gain calibration

Multiple gain calibrations at various radiation doses can be applied during acquisition in order to achieve the best image quality possible.

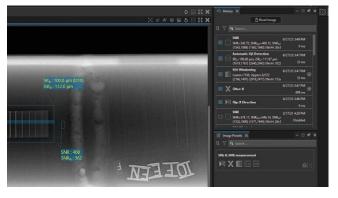
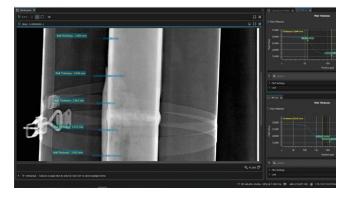


Image operation history and presets

Every action applied to an image since it was imported or acquired is recorded and each can be individually activated or deactivated. Any combination of actions can also be saved as a preset and applied to other images with a single click.



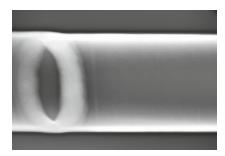
One-click Wall Thickness Tool

This optional tool determines the thickness at one or more points along the wall of a pipe. The measurement is performed with a single click on the point to be measured and can be moved if necessary.

Technical data	D-DR 1025B NDT	D-DR 1043B NDT	D-DR 7 NDT
Active area	97 mm x 249 mm (3.82" x 9.8")	97 mm x 427 mm (3.82" x 16.8")	26 mm x 36 mm (1.0 x 1.4")
Bendable	Minimum pipe diameter 150 mm (6")	Minimum pipe diameter 300 mm (12")	N/A
Dimensions detector / incl. housing $(H \times W \times D)$	182 mm x 453 mm x 20 mm 225 mm x 555 mm x 34 mm	182 mm x 633 mm x 20 mm 225 mm x 733 mm x 34 mm	31.5 mm x 50 mm x 8.3 mm
Weight detector / incl. housing	1.5 kg (3.3 lbs) 2.0 kg (4.4 lbs)	1.7 kg (3.7 lbs) 2.2 kg (4.8 lbs)	0.15 kg (0.33 lbs)
Number of pixels	981 x 2517	981 x 4309	1368 x 1896
Frame time	0.5 s to 180 s	0.5 s to 180 s	0.5 s to 180 s
Image transfer time (wired/wireless)	1.5 s / 3 s	1.5 s / 3 s	2 s / -
Maximum energy	450 kV (for long life in typical applications)	450 kV (for long life in typical applications)	70 kV (for long life in typical applications)
Pixel pitch	99 µm	99 µm	19 µm
Maximum SR _b (basic spatial resolution)	100 μm (Fine), 130 μm (Standard)	100 μm (Fine), 130 μm (Standard)	25 μm
Scintillator options	GOS Fine, GOS Standard	GOS Fine, GOS Standard	Csl
ADC	16-bit	16-bit	12-bit
Interface	Gigabit Ethernet, WLAN: 2.4 GHz (802.11n) / 5 GHz (802.11ac)	Gigabit Ethernet, WLAN: 2.4 GHz (802.11n) / 5 GHz (802.11ac)	USB 2.0, USB 3.0 compatible (cable length 4.5 m)
Battery	Lithium-ion (11.55 V, 39.3 Wh)	Lithium-ion (11.55 V, 39.3 Wh)	-
Operating conditions	-20 to 50°C (-4 to 122°F), 10 to 90 % humidity	-20 to 50°C (-4 to 122°F), 10 to 90 % humidity	10 to 35°C (50 to 95°F), < 80 % humidity
Protection level	IP67 (dust-tight and waterproof)	IP67 (dust-tight and waterproof)	-
Software	DÜRR NDT D-Tect X	DÜRR NDT D-Tect X	DÜRR NDT D-Tect 9.5 or higher
Accessories			Positioning tool with shieldings



The D-DR 1025B NDT can be bent continuously from flat to a 150 mm diameter in one direction, the D-DR 1043B NDT to a 300 mm diameter.



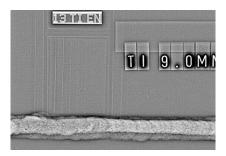
Weld seam, 5 mm diameter pipe with 1.2 mm wall thickness, X-ray (13 FE ISO: W19).

384 mm × 460 mm × 15 mm 470 mm × 602 mm × 25 mm
4.1 kg (9 lbs) 6.1 kg (13.4 lbs)
3548 x 4316
0.5 s to 180 s
3.5 s / 5 s
450 kV (for long life in typical applications), Isotopes (with typical in-field usage)
99 µm
100 µm (Fine), 130 µm (Standard), 160 µm (Plus)
GOS Fine, GOS Standard, GOS Plus
16-bit
Gigabit Ethernet, WLAN: 2.4 GHz (802.11n) / 5 GHz (802.11ac)
2 x Lithium-ion (11.55 V, 39.3 Wh)
-20 to 50°C (-4 to 122°F), 10 to 90 % humidity
IP67 (dust-tight and waterproof)
DÜRR NDT D-Tect X

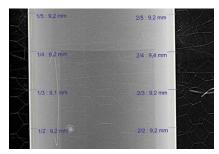
Bendable N/A N/A N/A N/A Dimensions detector / incl. housing (H x W x D) 132 mm x 335 mm x 30 mm 322 mm x 355 mm x 17 mm 384 mm x 460 mm x 15 mm Weight detector / incl. housing 184 mm x 421 mm x 44 mm 391 mm x 473 mm x 27 mm 470 mm x 602 mm x 25 mm Weight detector / incl. housing 2.2 kg (4.9 lbs) 3.4 kg (7.5 lbs) 4.1 kg (9 lbs) incl. housing 2.9 kg (6.4 lbs) 4.7 kg (10.3 lbs) 6.1 kg (13.4 lbs) Number of pixels 1280 x 3072 3072 x 3840 3548 x 4316 Frame time 0.5 s to 180 s 3 s to 180 s 0.5 s to 180 s Image transfer time (wired/wireless) 1.9 s / 2.6 s 2 s / 3 s 3.5 s / 5 s Maximum energy 350 kV (for long life in typical applications), Isotopes (with typical applications) 450 kV (for long life in typical applications), Isotopes (with typical in-field usage) Pixel pitch 76 μm 75 μm 99 μm Maximum SR, (basic spotial resolution) 80 μm (Ultra-Fine), 130 μm (Plus) 80 μm (Plus) Scintillator options GOS Ultra-Fine, GOS Plus GOS Ultra-Fine GOS Fine, GOS Standard, GOS Plus ADC	Technical data	D-DR 1024 NDT	D-DR 2329 NDT	D-DR 3643 NDT
Dimensions detector / incl. housing 132 mm x 335 mm x 30 mm 322 mm x 355 mm x 17 mm 384 mm x 460 mm x 15 mm Veright detector / incl. housing 2.2 kg 4.9 lbs 3.4 kg 7.5 lbs 4.1 kg 9 lbs Weight detector / incl. housing 2.9 kg (6.4 lbs) 3.4 kg 7.5 lbs 4.1 kg 9 lbs Number of pixels 1280 x 3072 3072 x 3840 3548 x 4316 Frame time 0.5 s to 180 s 3 s to 180 s 0.5 s to 180 s Image transfer time (wired/wireless) 1.9 s / 2.6 s 2 s / 3 s 3.5 s / 5 s Maximum energy 350 kV (for long life in typical applications), Isotopes (with typical in-field usage) 450 kV (for long life in typical applications), Isotopes (with typical in-field usage) 450 kV (for long life in typical applications), Isotopes (with typical in-field usage) Pixel pitch 76 µm 75 µm 99 µm Maximum SR, (basic spatial resolution) 80 µm (Plus) 80 µm (Plus) 100 µm (Fine), 130 µm (Standard), 160 µm (Plus) Scintillator options GOS Ultra-Fine, GOS Plus GOS Ultra-Fine GOS Fine, GOS Standard, GOS Plus ADC 16-bit 16-bit 16-bit 16-bit 16-bit Interface G	Active area	97 mm x 233 mm (3.82" x 9.2")	230 mm x 288 mm (9.05" x 11.33")	351 mm x 427 mm (13.8" x 16.8")
184 mm x 421 mm x 44 mm 391 mm x 473 mm x 27 mm 470 mm x 602 mm x 25 mm 471 mm x 602 mm	Bendable	N/A	N/A	N/A
Number of pixels 1280 x 3072 3072 x 3840 3548 x 4316	Dimensions detector / incl. housing $(H \times W \times D)$	184 mm x 421 mm x 44 mm		
Frame time 0.5 s to 180 s 3 s to 180 s 0.5 s to 180 s Image transfer time (wired/wireless) 19 s / 2.6 s 2 s / 3 s 3.5 s / 5 s Maximum energy 350 kV (for long life in typical applications), Isotopes (with typical in-field usage) 450 kV (for long life in typical applications) 450 kV (for long life in typical applications), Isotopes (with typical in-field usage) Pixel pitch 76 μm 75 μm 90 μm Maximum SR _b (basic spatial resolution) 80 μm (Ultra-Fine), 130 μm (Plus) 80 μm 100 μm (Fine), 130 μm (Standard), 160 μm (Plus) Scintillator options GOS Ultra-Fine, GOS Plus GOS Ultra-Fine GOS Fine, GOS Standard, GOS Plus ADC 16-bit 16-bit 16-bit 16-bit Interface Gigabit Ethernet, WLAN: 2.4 GHz (802.11ac) Battery Lithium-ion (11.25 V, 33.2 Wh) 2 x Lithium-ion (76 V, 23.6 Wh) 2 x Lithium-ion (11.55 V, 39.3 Wh) Operating conditions 0 to 45°C (32 to 113°F), 30 to 85 % humidity 20 to 50°C (-4 to 122°F), 10 to 90 % humidity 20 to 50°C (-4 to 122°F), 10 to 90 % humidity 20 to 50°C (-4 to 122°F), 10 to 90 % humidity 20 to 50°C (-4 to 122°F), 10 to 90 % humidity <t< th=""><th>Weight detector / incl. housing</th><th></th><th></th><th>• • • • • • • • • • • • • • • • • • • •</th></t<>	Weight detector / incl. housing			• • • • • • • • • • • • • • • • • • • •
Image transfer time (wired/wireless) 1.9 s / 2.6 s 2 s / 3 s 3.5 s / 5 s Maximum energy 350 kV (for long life in typical applications), Isotopes (with typical in-field usage) 450 kV (for long life in typical applications), Isotopes (with typical in-field usage) Pixel pitch 76 μm 75 μm 99 μm Maximum SR ₈ (basic spatial resolution) 80 μm (Ultra-Fine), 130 μm (Plus) 80 μm 100 μm (Fine), 130 μm (Standard), 160 μm (Plus) Scintillator options GOS Ultra-Fine, GOS Plus GOS Ultra-Fine GOS Fine, GOS Standard, GOS Plus ADC 16-bit 16-bit 16-bit Interface Gigabit Ethernet, WLAN: 2.4 GHz (802.11ac) Gigabit Ethernet, WLAN: 2.4 GHz (802.11ac) Gigabit Ethernet, WLAN: 2.4 GHz (802.11ac) Battery Lithium-ion (11.25 V, 33.2 Wh) 2 x Lithium-ion (76 V, 23.6 Wh) 2 x Lithium-ion (11.55 V, 39.3 Wh) Operating conditions 0 to 45°C (32 to 113°F), 30 to 85 % humidity -20 to 50°C (-4 to 122°F), -20 to 50°C (-4 to 122°F), 10 to 90 % humidity -20 to 50°C (-4 to 122°F), 10 to 90 % humidity Protection level DÜRR NDT D-Tect X DÜRR NDT D-Tect X DÜRR NDT D-Tect X	Number of pixels	1280 x 3072	3072 x 3840	3548 x 4316
Maximum energy 350 kV (for long life in typical applications), Isotopes (with typical in-field usage) 75 μm 99 μm Maximum SR _b (basic spatial resolution) Scintillator options ADC 16-bit 16	Frame time	0.5 s to 180 s	3 s to 180 s	0.5 s to 180 s
applications), Isotopes (with typical in-field usage) Pixel pitch 76 μm 75 μm 99 μm Maximum SR _b (basic spatial resolution) Scintillator options GOS Ultra-Fine, GOS Plus GOS Ultra-Fine GOS Ultra-Fine GOS Ultra-Fine GOS Fine, GOS Standard, GOS Plus ADC 16-bit 16-bit 16-bit 16-bit Gigabit Ethernet, WLAN: 2.4 GHz (802.11abgn) / 5 GHz (802.11ac) (802.11abgn) / 5 GHz (802.11ac) Battery Lithium-ion (11.25 V, 33.2 Wh) Operating conditions O to 45°C (32 to 113°F), 30 to 85 % humidity Protection level DÜRR NDT D-Tect X DÜRR NDT D-Tect X DÜRR NDT D-Tect X	Image transfer time (wired/wireless)	1.9 s / 2.6 s	2 s / 3 s	3.5 s / 5 s
Maximum SRb (basic spatial resolution)80 μm (Ultra-Fine), 130 μm (Plus)80 μm100 μm (Fine), 130 μm (Standard), 160 μm (Plus)Scintillator optionsGOS Ultra-Fine, GOS PlusGOS Ultra-FineGOS Fine, GOS Standard, GOS PlusADC16-bit16-bit16-bit16-bitInterfaceGigabit Ethernet, WLAN: 2.4 GHz (802.11ac)Gigabit Ethernet, WLAN: 2.4 GHz (802.11ac)Gigabit Ethernet, WLAN: 2.4 GHz (802.11ac)BatteryLithium-ion (11.25 V, 33.2 Wh)2 x Lithium-ion (7.6 V, 23.6 Wh)2 x Lithium-ion (11.55 V, 39.3 Wh)Operating conditions0 to 45°C (32 to 113°F), 30 to 85 % humidity-20 to 50°C (-4 to 122°F), 10 to 90 % humidity-20 to 50°C (-4 to 122°F), 10 to 90 % humidityProtection levelIP67 (dust-tight and waterproof)IP67 (dust-tight and waterproof)IP67 (dust-tight and waterproof)IP67 (dust-tight and waterproof)SoftwareDÜRR NDT D-Tect XDÜRR NDT D-Tect XDÜRR NDT D-Tect X	Maximum energy	applications), Isotopes (with typical	- · · ·	applications), Isotopes (with typical
Cost	Pixel pitch	76 μm	75 μm	99 µm
ADC 16-bit 18-bit 18-bit 18-bit 18-bit 18-bit 18-bit 18-bit 1802.11a) 2 x Lithium-ion (11.25 V, 32.6 Wh) 2 x Lithium-ion (11.55 V, 39.3 Wh) 2 x Lithium-ion (11.55 V, 39.3 Wh) 2 x Lithium-ion (11.55 V, 39.3 Wh) 2 x Lithium-ion (10.55 V, 39.3 Wh) 2 x Lithium-ion (10.55 V, 23.6 Wh) 2 x Lithium-ion (10.55 V, 39.3 Wh) 2 x Lithiu	Maximum SR _b (basic spatial resolution)	80 μm (Ultra-Fine), 130 μm (Plus)	80 μm	·
Interface Gigabit Ethernet, WLAN: 2.4 GHz (802.11abgn) / 5 GHz (802.11ac) Gigabit Ethernet, WLAN: 2.4 GHz (802.11n) / 5 GHz (802.11ac) Gigabit Ethernet, WLAN: 2.4 GHz (802.11n) / 5 GHz (802.11ac) Gigabit Ethernet, WLAN: 2.4 GHz (802.11n) / 5 GHz (802.11ac) Dithium-ion (11.25 V, 33.2 Wh) 2 x Lithium-ion (7.6 V, 23.6 Wh) 2 x Lithium-ion (11.55 V, 39.3 Wh) Operating conditions O to 45°C (32 to 113°F), 30 to 85 % humidity 10 to 90 % humidity 10 to 90 % humidity Protection level IP67 (dust-tight and waterproof) DÜRR NDT D-Tect X DÜRR NDT D-Tect X DÜRR NDT D-Tect X	Scintillator options	GOS Ultra-Fine, GOS Plus	GOS Ultra-Fine	GOS Fine, GOS Standard, GOS Plus
(802.11abgn) / 5 GHz (802.11ac) (802.11n) / 5 GHz (802.11ac) (802.11n) / 5 GHz (802.11ac) Battery Lithium-ion (11.25 V, 33.2 Wh) 2 x Lithium-ion (7.6 V, 23.6 Wh) 2 x Lithium-ion (11.55 V, 39.3 Wh) Operating conditions 0 to 45°C (32 to 113°F), 30 to 85 % humidity -20 to 50°C (-4 to 122°F), 10 to 90 % humidity -20 to 50°C (-4 to 122°F), 10 to 90 % humidity Protection level IP67 (dust-tight and waterproof) IP67 (dust-tight and waterproof) IP67 (dust-tight and waterproof) Software DÜRR NDT D-Tect X DÜRR NDT D-Tect X DÜRR NDT D-Tect X	ADC	16-bit	16-bit	16-bit
Operating conditions 0 to 45°C (32 to 113°F), 30 to 85 % humidity -20 to 50°C (-4 to 122°F), 10 to 90 % humidity -20 to 50°C (-4 to 122°F), 10 to 90 % humidity Protection level IP67 (dust-tight and waterproof) IP67 (dust-tight and waterproof) IP67 (dust-tight and waterproof) Software DÜRR NDT D-Tect X DÜRR NDT D-Tect X DÜRR NDT D-Tect X	Interface	~	-	_
30 to 85 % humidity 10 to 90 % humidity 10 to 90 % humidity Protection level IP67 (dust-tight and waterproof) IP67 (dust-tight and waterproof) IP67 (dust-tight and waterproof) Software DÜRR NDT D-Tect X DÜRR NDT D-Tect X	Battery	Lithium-ion (11.25 V, 33.2 Wh)	2 x Lithium-ion (7.6 V, 23.6 Wh)	2 x Lithium-ion (11.55 V, 39.3 Wh)
Software DÜRR NDT D-Tect X DÜRR NDT D-Tect X DÜRR NDT D-Tect X	Operating conditions			
	Protection level	IP67 (dust-tight and waterproof)	IP67 (dust-tight and waterproof)	IP67 (dust-tight and waterproof)
Accessories Positioning tool	Software	DÜRR NDT D-Tect X	DÜRR NDT D-Tect X	DÜRR NDT D-Tect X
	Accessories	Positioning tool		



Thin-walled stainless steel cylinder with longitudinal weld seam.



Weld seam, 9 mm titanium plate, X-ray (ISO 17636-2 Class B compliant).



Profile image, DN 150 x 9 mm, Iridium-192.

DÜRR NDT GmbH & Co. KG Höpfigheimer Straße 22 74321 Bietigheim-Bissingen Germany

